Octal D-type Flip-Flops (with 3-state outputs)

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Description

These devices are positive edge triggered flip-flops. The difference between HD74HC564 and HD74HC574 is only that the former has inverting outputs and the latter has noninvertering outputs.

Data at the D inputs, meeting the set-up and hold time requirements, are transferred to the Q or \overline{Q} outputs on positive going transitions of the clock (CK) input. when a high logic level is applied to the output cotrol (OC) input, all outputs go to a high impedance state, regardless of what signals are present at the other inputs and the state of the storage elements.

Features

• High Speed Operation: t_{pd} (Clock to Output) = 13 ns typ ($C_L = 50 \text{ pF}$)

• High Output Current: Fanout of 15 LSTTL Loads

• Wide Operating Voltage: $V_{CC} = 2$ to 6 V

Low Input Current: 1 μA max

• Low Quiescent Supply Current: I_{CC} (static) = 4 μ A max (Ta = 25°C)

Function Table

			Outputs				
Output Control	Clock	Data	HD74HC564	HD74HD574			
L		Н	L	Н			
L		L	Н	L			
L	L	Χ	$\overline{Q_{\scriptscriptstyle{0}}}$	Q_0			
Н	X	Х	Z	Z			

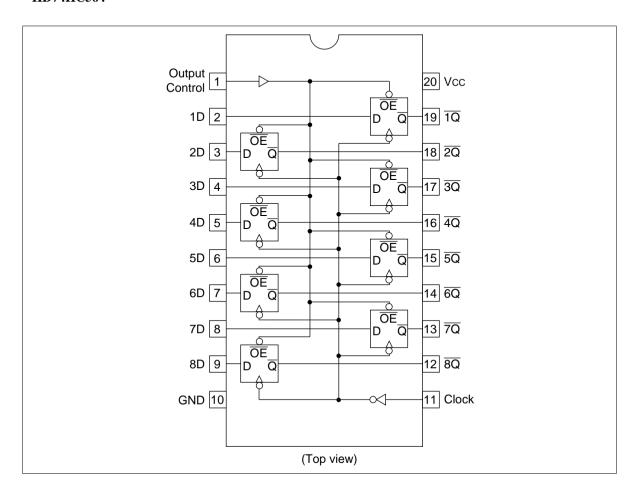
 ${\bf Q}_{\scriptscriptstyle 0}$: level of Q before the indicated Steady-sate input conditions were established.

 $\overline{Q_0}$: complement of Q_0 or level of \overline{Q} before the indicated Steady-state input Conditions were established.

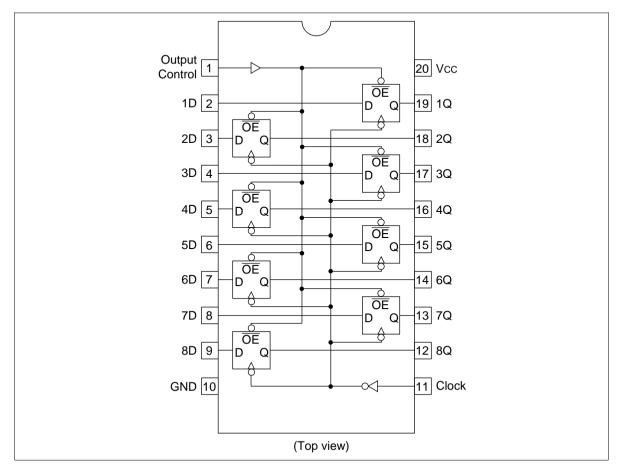


Pin Arrangement

HD74HC564



HD74HC574



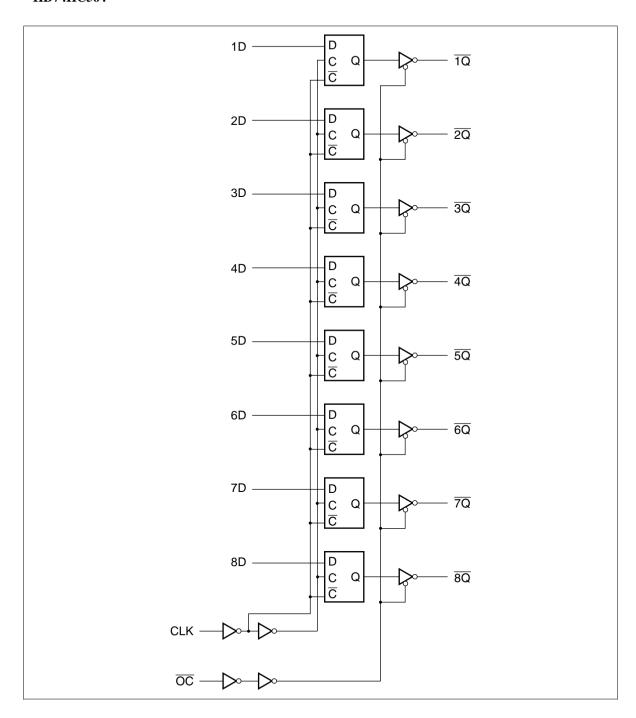
Absolute Maximum Ratings

Item	Symbol	Rating	Unit
Supply voltage range	V _{cc}	-0.5 to +7.0	V
Input voltage	V _{IN}	-0.5 to V_{cc} + 0.5	V
Output voltage	V _{out}	-0.5 to V_{CC} + 0.5	V
Output current	I _{OUT}	±35	mA
DC current drain per V_{CC} , GND	$I_{\rm CC},I_{\rm GND}$	±75	mA
DC input diode current	I _{IK}	±20	mA
DC output diode current	I _{ok}	±20	mA
Power Dissipation per package	P _T	500	mW
Storage temperature	Tstg	-65 to +150	°C

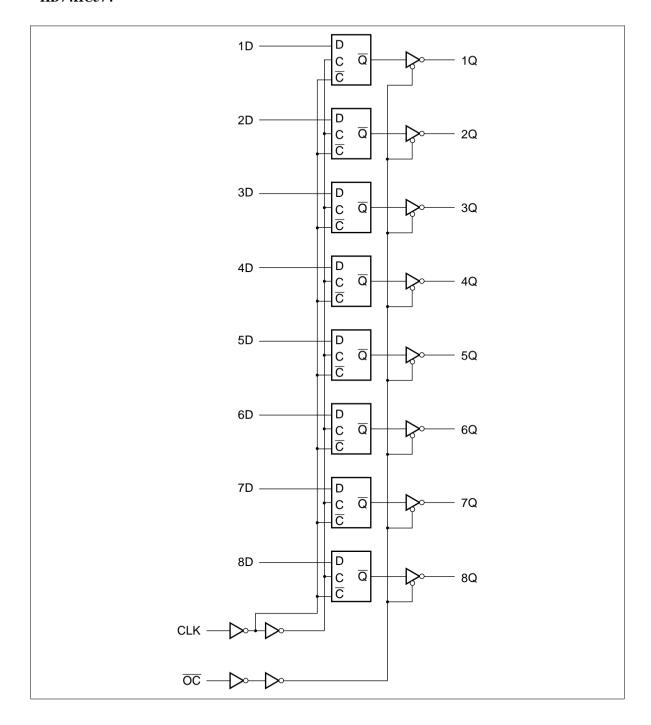
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Block Diagram

HD74HC564



HD74HC574



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DC Characteristics

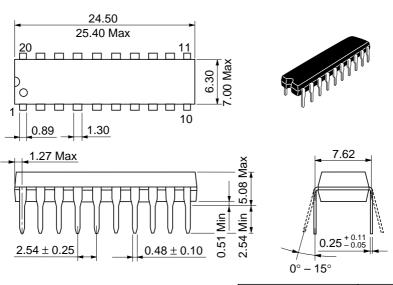
			Ta =	: 25°(Ta = - +85°C	-40 to			
Item	Symbol	V _{cc} (V)	Min	Тур	Max	Min	Max	Unit	Test Condition	ns
Input voltage	V _{IH}	2.0	1.5	_	_	1.5	_	V		
		4.5	3.15	_	_	3.15	_			
		6.0	4.2	_	_	4.2	_	_		
	V _{IL}	2.0	_	_	0.5	_	0.5	V		
		4.5	_	_	1.35	_	1.35			
		6.0	_	_	1.8	_	1.8	=		
Output voltage	V _{OH}	2.0	1.9	2.0	_	1.9	_	V	$Vin = V_{IH} \text{ or } V_{IL}$	I _{OH} = -20 μA
		4.5	4.4	4.5	_	4.4	_	_		
		6.0	5.9	6.0	_	5.9	_	=		
		4.5	4.18	_	_	4.13	_	_		$I_{OH} = -6 \text{ mA}$
		6.0	5.68	_	_	5.63	_	=		$I_{OH} = -7.8 \text{ mA}$
	V _{OL}	2.0	_	0.0	0.1	_	0.1	V	$Vin = V_{IH} \text{ or } V_{IL}$	I _{OL} = 20 μA
		4.5	_	0.0	0.1	_	0.1	_		
		6.0	_	0.0	0.1	_	0.1	-		
		4.5	_	_	0.26	_	0.33	-		I _{OL} = 6 mA
		6.0	_	_	0.26	_	0.33	=		I _{OL} = 7.8 mA
Off-state output current	I _{oz}	6.0	_	_	±0.5	_	±5.0	μΑ	$Vin = V_{IH} \text{ or } V_{IL},$ $Vout = V_{CC} \text{ or } C$	
Input current	lin	6.0	_	_	±0.1	_	±1.0	μΑ	Vin = V _{cc} or GN	ND
Quiescent supply current	I _{cc}	6.0	_	_	4.0	_	40	μΑ	Vin = V _{cc} or GN	ND, lout = $0 \mu A$

AC Characteristics ($C_L = 50 \text{ pF}$, Input $t_r = t_f = 6 \text{ ns}$)

	Ta = -40 to
Ta = 25°C	+85°C

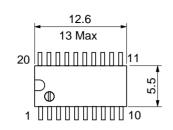
								_	
Item	Symbol	V _{cc} (V)	Min	Тур	Max	Min	Max	Unit	Test Conditions
Maximum clock	f _{max}	2.0	_	_	6	_	5	MHz	
frequency		4.5	_	_	30	_	24	-	
		6.0	_	_	35	_	28	_	
Propagation delay	t _{PLH}	2.0	_	_	155	_	195	ns	Clock to output
time	$t_{\tiny PHL}$	4.5	_	13	31	_	39	_	
		6.0	_	_	26	_	33	_	
Output enable	t _{zH}	2.0	_	_	150	_	190	ns	
time	$t_{_{ZL}}$	4.5	_	13	30	_	38	_	
		6.0	_	_	26	_	33	_	
Output disable	t _{HZ}	2.0	_	_	150	_	190	ns	
time	t _{LZ}	4.5	_	15	30	_	38	-	
		6.0	_	_	26	_	33	=	
Setup time	t _{su}	2.0	_	_	100	_	125	ns	
		4.5	_	1	20	_	25	_	
		6.0	_	_	17	_	21	-	
Hold time	t _h	2.0	5	_	_	5	_	ns	
		4.5	5	0		5	_	_	
		6.0	5	_	_	5	_	-	
Pulse width	t _w	2.0	80	_	_	100	_	ns	
		4.5	16	4	_	20	_	_	
		6.0	14	_	_	17	_	=	
Output rise/fall	t _{TLH}	2.0	_	_	60	_	75	ns	
time	t _{THL}	4.5	_	4	12	_	15	=	
		6.0	_	_	10	_	13	=	
Input capacitance	Cin	_	_	5	10	_	10	pF	

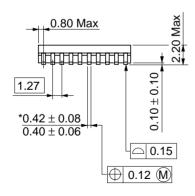
Unit: mm

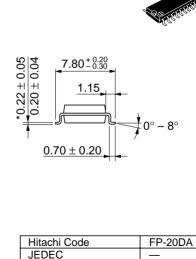


Hitachi Code	DP-20N
JEDEC	_
EIAJ	Conforms
Weight (reference value)	1.26 g

Unit: mm







Weight (reference value)

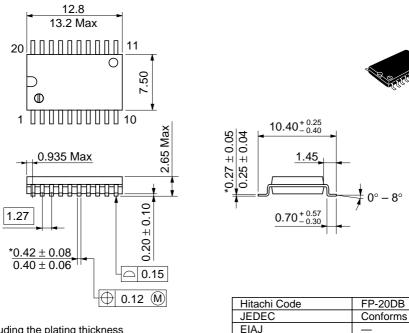
Conforms

0.31 g

EIAJ

*Dimension including the plating thickness
Base material dimension

Unit: mm



Weight (reference value)

0.52 g

*Dimension including the plating thickness
Base material dimension

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